

# 2011 International Workshop on EUV Lithography

June 13-17, 2011

Makena Beach Golf Resort ▪ Maui, Hawaii

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## Workshop Agenda



# **2011 International Workshop on EUV Lithography**

**Makena Beach Golf Resort, Maui, Hawaii, USA  
June 13-17, 2011**

## **Workshop Agenda Outline**

### **Short Courses (Makena Room, June 13, 2011)**

#### **EUV Lithography**

8:00 AM -5:00 PM, Monday, June 13, 2011

### **EUVL Workshop (June 14-17, 2011)**

#### **Tuesday, June 14, 2011**

3:00 PM- 5:00 PM                      Registration (Kaeo Ballroom Entry Lanai)  
   Speaker Prep (Wailea Room)

5:00 PM- 7:00 PM                      Reception (Pacific Lawn)

#### **Wednesday, June 15, 2011**

7:00 AM    –     8:00 AM    Breakfast

8:00 AM    –     12:00 PM    Oral Presentations (Wailea Room)

12:00 PM   –     1:00 PM     Lunch (Holokai Pavilion)

1:00 PM    –     4:00 PM     Oral Presentations (Wailea Room)

4:00 PM                                      Afternoon off for Networking /Sunset Cruise

**Thursday, June 16, 2011**

7:00 AM – 8:00 AM Breakfast

8:00 AM – 12:00 PM Oral Presentations (Wailea Room)

12:00 PM – 1:00 PM Lunch (Holokai Pavilion)

1:00 PM – 4:00 PM Oral Presentations (Wailea Room)

5:00 PM - 6:00 PM Poster Session

6:00 PM Dinner (Pacific Lawn)

**Friday, June 17, 2011**

8:30 AM – 10:00 AM EUVL Workshop Steering Committee Meeting  
(Kaeo Ballroom)

# **2011 International Workshop on EUV Lithography**

*Makena Beach Golf Resort, Maui, Hawaii, USA*  
*June 13-17, 2011*

## **Workshop Agenda**

### **Monday, June 13, 2011**

#### **Short Courses**

##### **EUV Lithography**

by Vivek Bakshi (EUV Litho, Inc.), Patrick Naulleau (LBNL) and Jinho Ahn (Hanyang University)

8:00 AM -5:00 PM, Monday, June 13, 2011

### **Tuesday, June 14, 2011**

#### **Registration and Reception**

3:00 PM- 5:00 PM                      Registration & Speaker Prep

5:00 PM- 7:00 PM                      Reception

**Wednesday, June 15, 2011**

**8:00 AM Welcome and Introduction**

Vivek Bakshi  
*EUV Litho, Inc., Austin, TX, USA*

**Session 1: Keynote Presentations**

**EUV Lithography and EUVL Sources: From the Beginning to NXE and Beyond (P1)**

Vadim Banine  
*ASML, Eindhoven, Netherlands*

**Development and Optimization of EUV Emission from Laser Produced Plasmas (P2)**

Gerry O'Sullivan  
*University College Dublin, Dublin, Ireland*

***Break***

**Session 2: EUV Sources**

**1<sup>st</sup>/2<sup>nd</sup> Generation Laser-Produced Plasma Light Source System for HVM EUV Lithography (P34) (Invited Paper)**

Hakaru Mizoguchi<sup>1</sup>, Tamotsu Abe, Yukio Watanabe, Takanobu Ishihara, Takeshi Ohta, Tsukasa Hori, Tatsuya Yanagida, Hitoshi Nagano, Takayuki Yabu, Shinji Nagai, Georg Soumagne, Akihiko Kurosu, Krzysztof M. Nowak, Takashi Sukanuma, Masato Moriya, Kouji Kakizaki, Akira Sumitani, Hidenobu Kameda<sup>1</sup>, Hiroaki Nakarai<sup>1</sup>, Junichi Fujimoto<sup>1</sup>

*EUVA/Komatsu (Japan): Hiratsuka, Kanagawa, Japan*

<sup>1</sup>*Gigaphoton (Japan): Oyama, Tochigi, Japan*

## **Optimization of Laser-produced Plasma Light Sources for EUV Lithography (P6)**

Mark Tillack and Yezheng Tao

*University of California, San Diego, La Jolla, CA*

## **High Brightness EUV & Soft-X-ray MPP Discharge Source System Development (P27)**

Peter Choi<sup>ab</sup>, Sergey V. Zakharov<sup>ab+</sup>, Raul Aliaga-Rossel<sup>a</sup>, Aldrice

Bakouboula<sup>a</sup>, Otman Benali<sup>ab</sup>, Philippe Bove<sup>a</sup>, Michèle Cau<sup>a</sup>, Grainne Duffy<sup>a</sup>, Blair Lebert<sup>b</sup>, Ouassima Sarroukh<sup>b</sup>, Clement Zaepffel<sup>a</sup>, Vasily S. Zakharov<sup>b</sup>

<sup>a</sup> *Nano-UV sas, Villebon/Yvette, France*

<sup>b</sup> *EPPRA sas, Villebon/Yvette, France*

<sup>+</sup> *also with NRC Kurchatov Institute, Moscow, Russia*

## **EQ-10 Electrodeless Z-Pinch EUV Source for Metrology Applications**

Deborah Gustafson, Stephen F. Horne, Matthew M. Besen, Donald K. Smith, Matthew J. Partlow, Paul A. Blackborow (P38)

*Energetiq Technology, Inc., Woburn, MA, USA 01801*

## **Progress on Liquid Metal Collector Mirrors as Robust Plasma Facing EUV and Soft X-ray Optics (P18)**

Kenneth Fahy, Fergal O'Reilly, Enda Scally, Padraig Dunne, Paul Sheridan

*University College Dublin, Dublin, Ireland*

## **Lunch (Holokai Pavilion)**

## **Session 3: EUV Source Modeling**

### **Comprehensive Simulation and Experimental Studies of EUV Lithography Source Issues (P22) (Invited Paper)**

A. Hassanein, T. Sizyuk, and S.S. Harilal

*Center for Materials Under Extreme Environment, School of Nuclear Engineering*

*Purdue University, West Lafayette, Indiana, USA*

## **Radiative Hydrodynamic Simulation of Laser-produced Tin Plasma for Extreme Ultraviolet Lithography (P10)**

Atsushi Sunahara<sup>1</sup>, Katsunobu Nishihara<sup>2</sup>, A. Sasaki<sup>3</sup>, and Tsukasa Hori<sup>4</sup>

<sup>1</sup> *Institute for Laser Technology, 2-6 Yamadaoka Suita Osaka 565-0871*

<sup>2</sup> *Institute of Laser Engineering, Osaka University, 2-6 Yamadaoka Suita Osaka 565-0871*

<sup>3</sup> *Quantum Beam Science Directorate, Japan Atomic Energy Agency, 8-1 Umemidai, Kizugawa Kyoto 619-0215 Japan*

<sup>4</sup> *EUVA*

## **Progress in Modelling of High Intensity Radiation Plasma Sources (P26)**

S.V. Zakharov<sup>ab+</sup>, V.S. Zakharov<sup>a</sup>, P. Choi<sup>ab</sup>, G. O'Sullivan<sup>d</sup>,  
A.Y. Krukovskiy<sup>c</sup>, V.G. Novikov<sup>c</sup>, A.D. Solomyannaya<sup>c</sup>, A.V. Berezin<sup>c</sup>, A.S. Vorontsov<sup>c</sup>, M.B. Markov<sup>c</sup>, S.V. Parot'kin<sup>c</sup>

<sup>a</sup> *EPPRA sas, Villebon/Yvette, France*

<sup>b</sup> *NANO-UV sas, Villebon/Yvette, France*

<sup>c</sup> *Keldysh Institute of Applied Mathematics RAS, Moscow, Russia*

<sup>d</sup> *University College Dublin (UCD), Ireland*

<sup>+</sup> *also with NRC Kurchatov Institute, Moscow, Russia*

## **Session 4: Next Generation EUV Sources**

### **Rare-Earth Plasma EUV Source at 6.7 nm for Future Lithography (P5)** (Invited Paper)

Takeshi Higashiguchi<sup>1,2</sup>, Takamitsu Otsuka<sup>1</sup>, Noboru Yugami<sup>1,2</sup>, Deirdre Kilbane<sup>3</sup>, Thomas Cummins<sup>3</sup>, Colm O'Gorman<sup>3</sup>, Tony Donnelly<sup>3</sup>, Padraig Dunne<sup>3</sup>, and Gerry O'Sullivan<sup>3</sup>, Weihua Jiang<sup>4</sup>, and Akira Endo<sup>5</sup>

<sup>1</sup> *Department of Advanced Interdisciplinary Sciences, and Center for Optical Research & Education (CORE) Utsunomiya University, Utsunomiya, Tochigi, Japan*

<sup>2</sup> *Japan Science and Technology Agency, CREST, Kanagawa, Saitama 332-0012, Japan*

<sup>3</sup> *School of Physics, University College Dublin, Belfield, Dublin 4, Ireland*

<sup>4</sup> *Department of Electrical Engineering, Nagaoka University of Technology, Nagaoka, Niigata, Japan*

<sup>5</sup> *Waseda University, Research Institute for Science and Engineering, Waseda University, Shinjuku, Tokyo, Japan*

**Atomic and Radiative Processes in Plasmas for the Shorter Wavelength Extreme ultra-violet (EUV) Light Sources (P7)**

Akira Sasaki

*Quantum Beam Science Directorate, Japan Atomic Energy Agency, Kizugawa-shi, Kyoto, Japan*

**Design of High Brightness Laser-Compton Light Source for EUV Lithography Research in Shorter Wavelength Region (P30) (Invited Paper)**

Kazuyuki Sakaue, Masakazu Washio, Akira Endo

*Research Institute of Science and Engineering, Waseda University, Shinjuku, Tokyo, Japan*

**Break**

**Session 5: Patterning**

**EUV Interference Lithography for 1X nm (P8)**

Takeo Watanabe, Yuya Yamaguchi, Takuro Urayama, Naohiro Matsuda, Tetsu Harada and Hiroo Kinoshita

*Center for EUVL, Laboratory of Advanced Science and Technology for Industry, University of Hyogo, Hyogo, Japan*

**EUV Lithography Simulation for the 16 nm Node (P17)**

Eun-Jin Kim, GukJin Kim, Seong-Sue Kim\*, Han-Ku Cho\*, Jinho Ahn\*\*, IIsin An,

and Hye-Keun Oh

*Lithography Lab., Department of Applied Physics, Hanyang University, Ansan, S. Korea*

*\*Samsung Electronics Co., LTD., Hwasung-City, Gyeonggi-Do, Korea*

*\*\*Department of Material Science and Engineering, Hanyang University, Seoul, S. Korea*

**LER Metrology: Can We Trust the Numbers? (P31) (Invited Paper)**

Patrick Naulleau

*Center for X-Ray Optics, Lawrence Berkeley National Laboratory, Berkeley, CA, USA*

**Adjourn at 4 PM**



**Thursday, June 16, 2011**

**8:00 AM Welcome and Announcements**

Vivek Bakshi  
*EUV Litho, Inc, Austin, TX USA*

**Session 6: EUVL R&D Status**

**Panelists:**

Greg Denbeaux – USA (University of Albany)

Hiroo Kinoshita –Japan (Hyogo University)

Padraig Dunne – Europe (University College Dublin)

Bryan, B. Y. Shew – Taiwan (NSRCC)

Jinho Ahn – Korea (Hanyang University)

***Break***

**Doing Business in Maui (P39)**

Kimberly Haueisen, Mark Ausbeck\*

*Maui Economic Development Board (MEDB), Inc., Kihei, Hawaii, USA*

*\* High Tech Development Corporation (HTDC), Kihei, Hawaii, USA*

**Session 7: EUVL Mask**

**Developing a New State of the Art EUV Mask Imaging Research Tool at Berkeley (P11) (Invited Paper)**

Kenneth Goldberg, Iacopo Mochi, Eric M. Gullikson, Erik H. Anderson, Patrick P. Naulleau

*Center for X-Ray Optics, Lawrence Berkeley National Laboratory, Berkeley, CA, USA*

**Overview of EUM Mask Inspection Systems in NewSUBARU (P15)**  
(Invited Paper)

Hiroo Kinoshita, Tetsuo Harada and Takeo Watanabe  
*Center for EUV Lithography, University of Hyogo, Japan*

**Development Status of EUVL Mask Blank and Substrate (P12)** (Invited Paper)

Kazunobu Maeshige  
*Central Research Center, Asahi Glass Co. Ltd., JAPAN*

**EUV Mask Production and Cleaning (P13)** (Invited Review Paper)

David N. Ruzic, Wayne Lytle, Daniel Andruczyk  
*UIUC, Urbana-Champaign, IL, USA*

**Session 8: EUV Resists**

**Feasibility Study of Chemically Amplified Resists for Short Wavelength Extreme Ultraviolet Lithography (P36)** (Invited Paper)

Takahiro Kozawa<sup>1</sup> and Andreas Erdmann<sup>2</sup>

<sup>1</sup>*The Institute of Scientific and Industrial Research, Osaka University, Ibaraki, Osaka, Japan*

<sup>2</sup>*Fraunhofer IISB, Erlangen, Germany*

**Recent Progress in Nano-space Radiation Chemistry Research on Sensitivity Enhancements of EUV Resists (P37)** (Invited Paper)

Seiichi Tagawa<sup>1,2</sup>

<sup>1</sup> *The Institute of Scientific and Industrial Research, Osaka University, Ibaraki, Osaka, Japan*

<sup>2</sup> *Japan Science and Technology Agency, CREST, c/o Osaka University, Ibaraki, Osaka, Japan*

**Lunch (Holokai Pavilion)**

## **Session 9: Optics Contamination**

### **Challenges in Development and Construction of Metrology, Calibration, and Resist Testing Tools for the Implementation of EUV Lithography (P3)**

Rupert C. C. Perera

*EUV Technology, Martinez, CA, USA*

### **Cleaning of Capped Multi-Layer Samples and Cleaning with Hydrogen using the Evactron® De-Contaminator (P23)**

Christopher G. Morgan and Ronald Vane

*XEI Scientific, Inc., Redwood City, CA, USA*

### **Mass Spectrometer Characterization of Reactions in Photoresists Exposed to Extreme Ultraviolet Radiation (P29)**

Chimaobi Mbanaso, Seth Kruger, Craig Higgins, Yashdeep Khopkar, Alin Antohe, Brian Cardineau, Gregory Denbeaux

*College of Nanoscale Science and Engineering, University at Albany, Albany, New York, USA*

## **Session 10: EUV Optics**

### **Status of Multilayer Coatings for EUV Lithography (P25) (Invited Review Paper)**

Yuriy Platonov<sup>1</sup>, Eric Louis<sup>2</sup>, Torsten Feigl<sup>3</sup>, Sergiy Yulin<sup>3</sup>, Jim Rodriguez<sup>1</sup>, Michael Kriese<sup>1</sup>

<sup>1</sup> *Rigaku Innovative Technologies, Auburn Hills, MI, USA,*

<sup>2</sup> *FOM Rijnhuizen, Nieuwegein, The Netherlands*

<sup>3</sup> *Fraunhofer IOF, Jena, Germany*

### **Developing Reflective Multilayer Coatings, an Enabling Component of Extreme Ultraviolet Lithography and Beyond (P24) (Invited Paper)**

E. Louis<sup>1</sup>, S. Müllender<sup>2</sup>, and F. Bijkerk<sup>1,3</sup>

<sup>1</sup> *FOM Rijnhuizen, Nieuwegein, The Netherlands,*

<sup>2</sup> *Carl Zeiss SMT AG, Oberkochen, Germany*

<sup>3</sup> *MESA+ Institute for Nano Technology, University of Twente, The Netherlands*

**Surface Metrology and Polishing Techniques for Current and Future-generation EUVL Optics** (P32) (Invited Review Paper)

Regina Soufli

*Lawrence Livermore National Laboratory, Livermore, California, US*

**WORKSHOP SUMMARY**

**EUVL Workshop Summary and Announcements**

Vivek Bakshi

*EUV Litho Inc, Austin, TX, USA*

**Thin Half-tone Phase Shift Mask Stack for Extreme Ultraviolet Lithography (P19)**

<sup>1</sup>Inhwan Lee, <sup>2</sup>Sangsul Lee, <sup>2</sup>Jae Uk Lee, <sup>2</sup>Chang Young Jeong, <sup>3</sup>Sunyoung Koo, <sup>3</sup>Changmoon Lim, and <sup>1,2</sup>Jinho Ahn

<sup>1</sup>*Department of Nanoscale Semiconductor Engineering,*

<sup>2</sup>*Department of Material Science and Engineering, Hanyang University, Seoul 133-791, Korea*

<sup>3</sup>*Memory Research & Development Division, Hynix Semiconductor Inc., San 136-1 Ami-ri, Bubal-eub, Icheon-si, Kyungki-do, 467-701, Korea*

**EUVL Flare Modeling with an Improved Accuracy for Feasibility Study of Sub-22nm HP Node (P21)**

Junhwan Lee, Sangheon Lee and Ohyun Kim

*Department of Electronic and Electrical Engineering, Pohang University of Science and Technology, Korea*

**B<sub>4</sub>C/Si based EUV Multilayer Mirror with Suppressed Reflectivity for CO<sub>2</sub> Laser Radiation (P4)**

V.V. Medvedev<sup>1,2</sup>, A.E. Yakshin<sup>1</sup>, R.W.E. van de Kruijs<sup>1</sup>, V.M. Krivtsun<sup>2</sup>, A.M. Yakunin<sup>3</sup>, F. Bijkerk<sup>1,4</sup>

<sup>1</sup>*FOM Institute for Plasma Physics, Nanolayer- Surface and Interface Physics department, Nieuwegein, The Netherlands*

<sup>2</sup>*Institute for Spectroscopy RAS, Troitsk, Moscow region, Russia*

<sup>3</sup>*ASML, Veldhoven, The Netherlands*

<sup>4</sup>*MESA+, University of Twente, Enschede, The Netherlands*

**EUV Spectra of Gadolinium Laser Produced Plasmas (P16)**

Colm O' Gorman<sup>1</sup>, Takamitsu Otsuka<sup>2</sup>, Takeshi Higashiguchi<sup>1</sup>, Akira Endo<sup>3</sup>, Tony Donnelly<sup>1</sup>, Bowen Li<sup>1</sup>, Thomas Cummins<sup>1</sup>, Deirdre Kilbane<sup>1</sup>, Emma Sokell<sup>1</sup>, Padraig Dunne<sup>1</sup> and Gerry O' Sullivan<sup>1</sup>

<sup>1</sup>*School of Physics, University College Dublin, Dublin 4, Ireland*

<sup>2</sup>*Department of Advanced Interdisciplinary Sciences and Centre of Optical Research and Education (CORE), Utsunomiya University, Yoto 7-1-2, Utsunomiya, Tochigi, 321 – 8585, Japan*

<sup>3</sup>*Forschungszentrum Dresden, Bautznew Landstrs. 400, Dresden D-01238, Germany*

**Laser Plasma Pumping by Variable-length CO<sub>2</sub> Laser Pulses (P20)**

Thomas Cummins, Marie Mazoyer, Gerry O'Sullivan, Padraig Dunne, Emma Sokell, Fergal O'Reilly, Colm O'Gorman and Tony Donnelly  
*Atomic, Molecular and Plasma Spectroscopy group, School of Physics, University College Dublin, Dublin, Ireland*

**Gas-based Spectral Filter for Mitigating 10.6 μm Radiation in CO<sub>2</sub> Laser Produced Plasma Extreme Ultraviolet Sources (P28)**

Chimaobi Mbanaso<sup>1</sup>, Gregory Denbeaux<sup>1</sup>, Alin Antohe<sup>1</sup>, Horace Bull<sup>1</sup>  
Frank Goodwin<sup>2</sup>, Ady Hershcovitch<sup>3</sup>

<sup>1</sup> *College of Nanoscale Science and Engineering, University at Albany, Albany, New York, USA*

<sup>2</sup> *SEMATECH, Albany, New York, USA*

<sup>3</sup> *Brookhaven National Laboratory, Upton, New York, USA*

**6:00 Dinner and Adjourn**

**Friday, June 17, 2011**

**EUVL Workshop Steering Committee Meeting**

8:30 AM

Breakfast

9:00 -10: 00 AM

EUVL Workshop Steering Committee Meeting

